

SEMICONDUCTOR

# **FDMC7680** N-Channel Power Trench<sup>®</sup> MOSFET 30 V, 14.8 A, 7.2 m $\Omega$

### Features

- Max r<sub>DS(on)</sub> = 7.2 mΩ at V<sub>GS</sub> = 10 V, I<sub>D</sub> = 14.8 A
- Max r<sub>DS(on)</sub> = 9.5 mΩ at V<sub>GS</sub> = 4.5 V, I<sub>D</sub> = 12.4 A
- High performance technology for extremely low r<sub>DS(on)</sub>
- Termination is Lead-free and RoHS Compliant

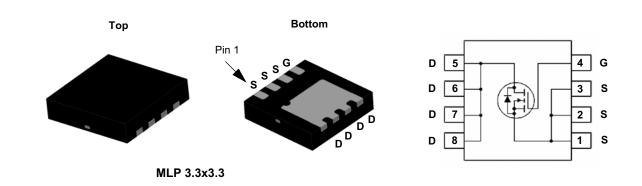


# **General Description**

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench<sup>®</sup> process that has been especially tailored to minimize the on-state resistance. This device is well suited for Power Management and load switching applications common in Notebook Computers and Portable Battery Packs.

### Application

- DC DC Buck Converters
- Notebook battery power management
- Load switch in Notebook



# MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	Parameter		Ratings	Units		
V <sub>DS</sub>	Drain to Source Voltage			30	V	
V <sub>GS</sub>	Gate to Source Voltage			±20	V	
	Drain Current -Continuous (Package limited)	T <sub>C</sub> = 25 °C		18		
ID	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	14.8	Α	
	-Pulsed		45			
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	72	mJ	
P <sub>D</sub>	Power Dissipation $T_{C} = 25 \text{ °C}$			31	w	
	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.3	vv	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C	

### **Thermal Characteristics**

$R_{\theta JC}$	Thermal Resistance, Junction to Case	4.0	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient (Note 1a)	53	C/VV

### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMC7680	FDMC7680	MLP 3.3x3.3	13 "	12 mm	3000 units

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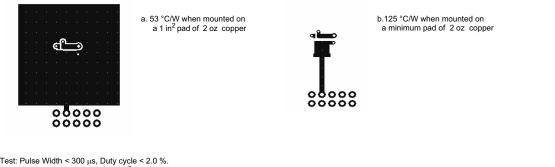
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	cteristics						
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V	30			V	
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D$ = 250 µA, referenced to 25 °C		15		mV/°C	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 24 V, V <sub>GS</sub> = 0 V T <sub>J</sub> = 125 °C			1 250	- μΑ	
I <sub>GSS</sub>	Gate to Source Leakage Current	V <sub>GS</sub> = 20 V, V <sub>DS</sub> = 0 V			100	nA	
On Chara	cteristics						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250 μA	1.2	2.0	3.0	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_{J}}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-6		mV/°0	
0		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 14.8 A		5.8	7.2		
r	Static Drain to Source On Resistance	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 12.4 A		7.3	9.5	0.5 mΩ	
r <sub>DS(on)</sub>		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 14.8 A T <sub>J</sub> = 125 °C		7.4	9.2	- 1115.2	
9 <sub>FS</sub>	Forward Transconductance	V <sub>DD</sub> = 5 V, I <sub>D</sub> = 14.8 A		68		S	
Dynamic	Characteristics						
C <sub>iss</sub>	Input Capacitance			2145	2855	pF	
C <sub>oss</sub>	Output Capacitance	— V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V, — f = 1 MHz		770	1020	pF	
C <sub>rss</sub>	Reverse Transfer Capacitance			75	115	pF	
R <sub>g</sub>	Gate Resistance			0.5	1.6	Ω	
Switching	g Characteristics						
t <sub>d(on)</sub>	Turn-On Delay Time			12	22	ns	
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 15 V, I <sub>D</sub> = 14.8 A,		4	10	ns	
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		25	40	ns	
t <sub>f</sub>	Fall Time			3	10	ns	
	Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V		30	42	nC	
Q <sub>g(TOT)</sub>	Total Gate Charge	V <sub>GS</sub> = 0 V to 4.5 V V <sub>DD</sub> = 15 V		14	19	nC	
Q <sub>gs</sub>	Total Gate Charge	I <sub>D</sub> = 14.8 A		7		nC	
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			4		nC	

### **Drain-Source Diode Characteristics**

	Source to Drain Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 14.8 A (Note 2)	0.84	1.2	V
V <sub>SD</sub> Source to Drain Diode Forward Voltage V		V <sub>GS</sub> = 0 V, I <sub>S</sub> = 1.9 A (Note 2)	0.73	1.2	) v
t <sub>rr</sub>	Reverse Recovery Time	I <sub>⊏</sub> = 14.8 A, di/dt = 100 A/μs	34	54	ns
Q <sub>rr</sub>	Reverse Recovery Charge	$T_F = 14.6 \text{ A}, \text{ di/dt} = 100 \text{ A/} \mu \text{s}$	15	24	nC

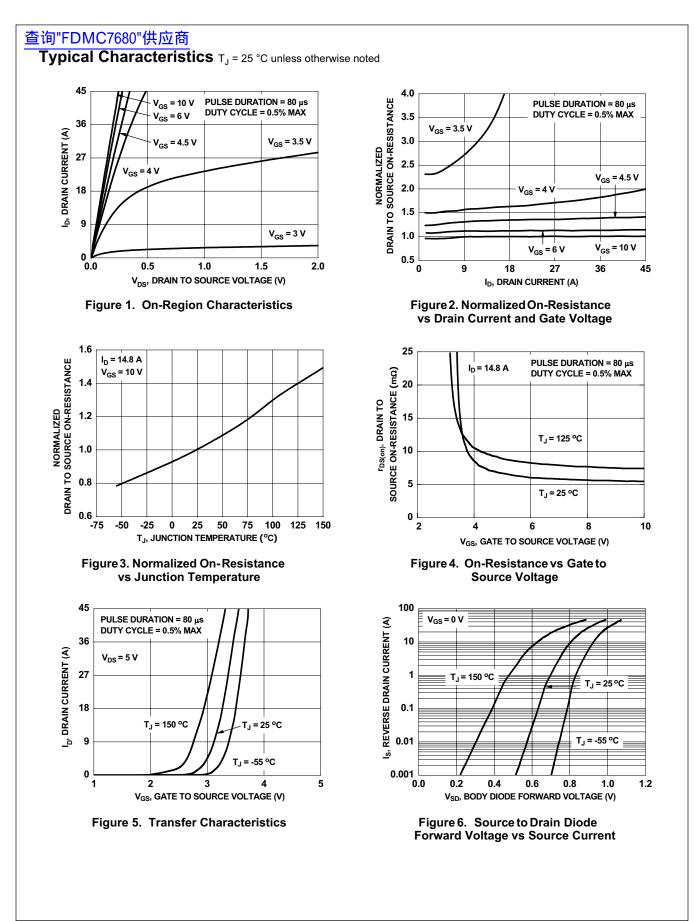
NOTES:

1: R<sub>0,1,4</sub> is determined with the device mounted on a 1 in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R<sub>0,1C</sub> is guaranteed by design while R<sub>0CA</sub> is determined by the user's board design.

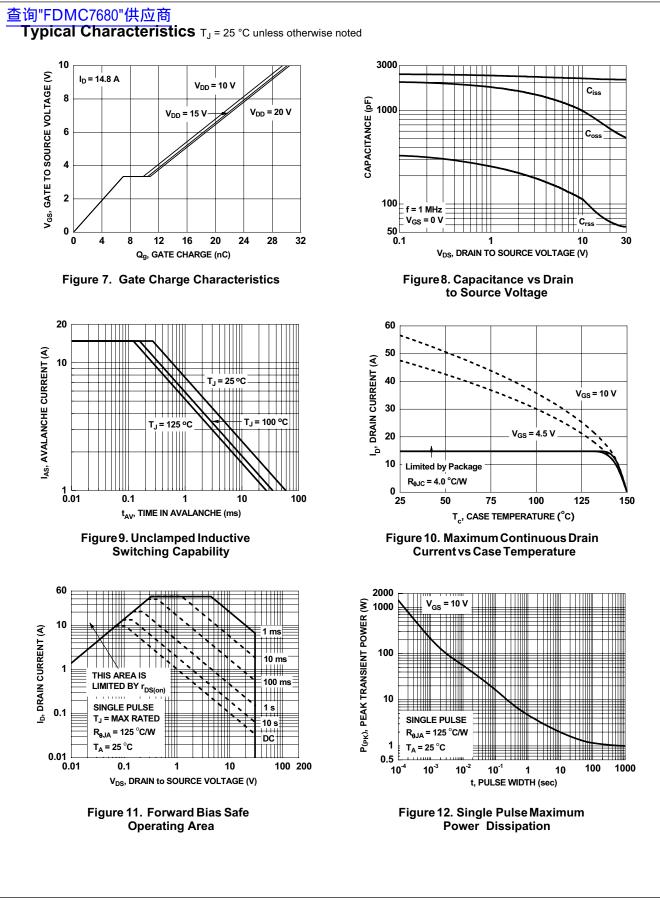


2: Pulse Test: Pulse Width < 300  $\mu$ s, Duty cycle < 2.0 %. 3: E<sub>AS</sub> of 72 mJ is based on starting T<sub>J</sub> = 25 °C, L = 1 mH, I<sub>AS</sub> = 12 A, V<sub>DD</sub> = 27 V, V<sub>GS</sub> = 10 V.

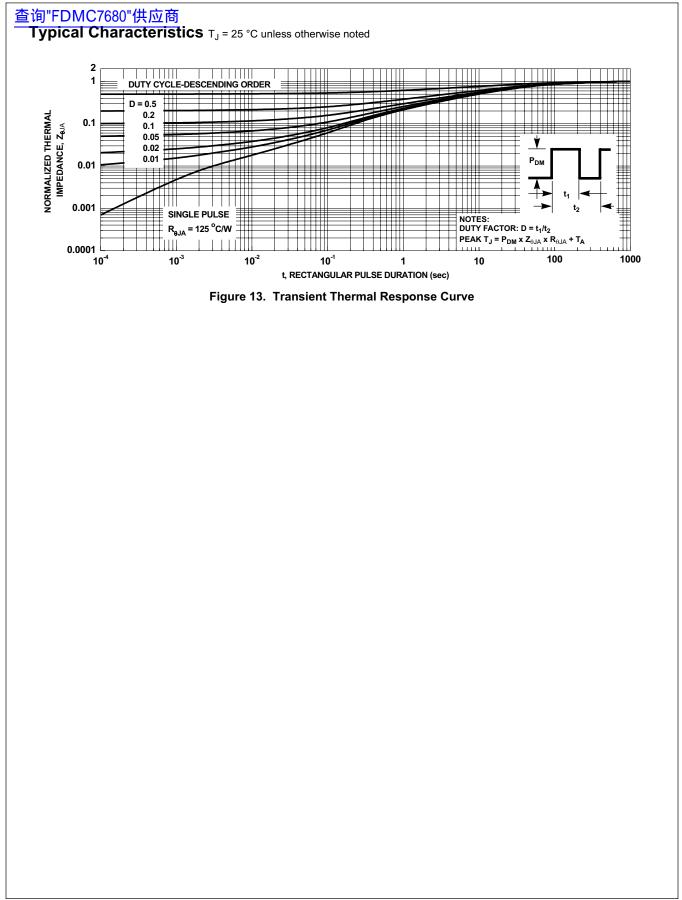
FDMC7680 N-Channel Power Trench<sup>®</sup> MOSFET



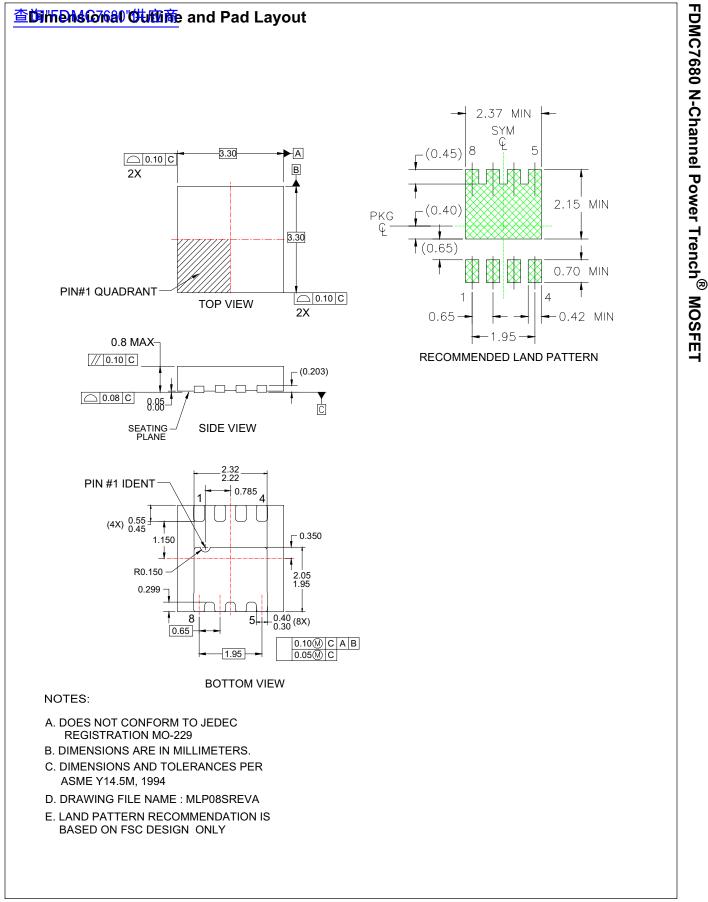
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